
OLIFF & BERRIDGE, PLC

ATTORNEYS AT LAW

Application Data Sheet**Application Information**

Application Type:: Regular
Subject Matter:: Utility
CD-ROM or CD-R: None
Title:: BUMP STRUCTURE AND METHOD OF
MANUFACTURING THE SAME, AND MOUNTING
STRUCTURE FOR IC CHIP AND CIRCUIT
BOARD

Attorney Docket Number:: 119593
Suggested Drawing Figure::
Total Drawing Sheets:: 9
Small Entity:: No

Applicant Information

Applicant Authority type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Tsuyoshi
Family Name:: KANEKO
City of Residence:: Suwa-shi
Country of Residence:: JAPAN

Country of Residence::

Correspondence Information

Correspondence Customer Number:: 25944

Foreign Priority Information			
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-169051	6/13/2003	Yes
Assignee Information			
Assignee Name::		SEIKO EPSON CORPORATION	
Street of mailing address::		4-1, Nishishinjuku 2-chome, Shinjuku-ku,	
City of mailing address::		Tokyo	
Country of mailing address::		JAPAN	
Postal or Zip Code of mailing address::		163-0811	